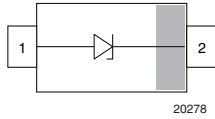
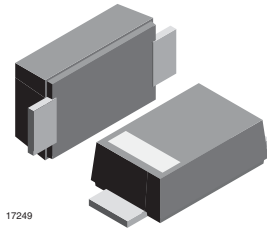




## Surface Mount ESD Protection Diodes



20278



17249

### MARKING (example only)



22623

Bar = cathode marking  
YY = type code (see table below)  
XX = date code

### FEATURES

- 200 W peak pulse power capability with a 10/1000  $\mu$ s waveform, repetition rate (duty cycle): 0.01 %
- Low-profile package
- Wave and reflow solderable
- ESD-protection acc. IEC 61000-4-2  $\pm$  30 kV contact discharge  $\pm$  30 kV air discharge
- Low incremental surge resistance, excellent clamping capability
- “Low-Noise” technology - very fast response time
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



ORDERING INFORMATION							
PART NUMBER (EXAMPLE)	ENVIRONMENTAL AND QUALITY CODE				PACKAGING CODE		ORDERING CODE (EXAMPLE)
	AEC-Q101 QUALIFIED	RoHS-COMPLIANT + LEAD (Pb)-FREE TERMINATIONS		TIN PLATED	3K PER 7" REEL (8 mm TAPE), 30K/BOX = MOQ	10K PER 13" REEL (8 mm TAPE), 50K/BOX = MOQ	
		STANDARD	HALOGEN-FREE				
SMF5V0A-		E		3	-08		SMF5V0A-E3-08
SMF5V0A-			M	3	-08		SMF5V0A-M3-08
SMF5V0A-	H	E		3	-08		SMF5V0A-HE3-08
SMF5V0A-	H		M	3	-08		SMF5V0A-HM3-08
SMF5V0A-		E		3		-18	SMF5V0A-E3-18
SMF5V0A-			M	3		-18	SMF5V0A-M3-18
SMF5V0A-	H	E		3		-18	SMF5V0A-HE3-18
SMF5V0A-	H		M	3		-18	SMF5V0A-HM3-18

PACKAGE DATA									
PACKAGE NAME	MOLDING COMPOUND	WEIGHT (mg)	HEIGHT MAX. (mm)	LENGTH MAX. (mm)	WIDTH MAX. (mm)	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	WHISKER TEST ACC. JESD 201	SOLDERING CONDITIONS
SMF (DO-219AB)	Standard	15	1.08	3.9	1.9	UL 94 V-0	MSL level 1 (acc. J-STD-020)	class 2	Peak temperature max. 260 °C
	Halogen-free								



ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	t <sub>p</sub> = 10/1000 μs waveform	I <sub>PPM</sub>	see "Electrical Characteristics"	A
Peak pulse power	t <sub>p</sub> = 8/20 μs waveform acc. IEC 61000-4-5	P <sub>PP</sub>	1000	W
	t <sub>p</sub> = 10/1000 μs waveform		200	W
Peak forward surge current	8.3 ms single half sine-wave	I <sub>FSM</sub>	50	A
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		± 30	kV
Thermal resistance	Mounted on epoxy glass PCB with 3 mm x 3 mm, Cu pads (≥ 40 μm thick)	R <sub>thJA</sub>	180	K/W
Forward clamping voltage	I <sub>F</sub> = 50A, t <sub>p</sub> = 400 μs	V <sub>F</sub>	2.5	V
Junction temperature		T <sub>J</sub>	175	°C
Storage temperature range		T <sub>stg</sub>	-65 to +175	°C
Operating temperature range		T <sub>op</sub>	-65 to +175	°C

ELECTRICAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)										
PART NUMBER	TYPE CODE		REVERSE BREAKDOWN VOLTAGE at I <sub>T</sub> , t <sub>p</sub> = 5 ms	TEST CURRENT	REVERSE WORKING VOLTAGE	REVERSE CURRENT at V <sub>RWM</sub>	PEAK PULSE CURRENT t <sub>p</sub> = 10/1000 μs	REVERSE CLAMPING VOLTAGE at I <sub>PPM</sub>	CAPACITANCE at V <sub>R</sub> = 0 V, f = 1 MHz	PROTECTION PATHS
	STD.	HALOGEN-FREE	V <sub>BR</sub> MIN. (V)	I <sub>T</sub> (mA)	V <sub>RWM</sub> (V)	I <sub>R</sub> (μA)	I <sub>PPM</sub> (A)	V <sub>C</sub> MAX. (V)	C <sub>D</sub> TYP. (pF)	N <sub>channel</sub>
SMF5V0A	AE	NE	6.40	10	5	5	21.7	9.2	1120	1
SMF6V0A	AG	NG	6.67	10	6	26	19.4	10.3	1063	1
SMF6V5A	AK	NK	7.22	10	6.5	20	17.9	11.2	938	1
SMF7V0A	AM	NM	7.78	10	7	3	16.7	12	843	1
SMF7V5A	AP	NP	8.33	1	7.5	0.1	15.5	12.9	773	1
SMF8V0A	AR	NR	8.89	1	8	0.1	14.7	13.6	706	1
SMF8V5A	AT	NT	9.44	1	8.5	0.1	13.9	14.4	674	1
SMF9V0A	AV	NV	10	1	9	0.1	13.5	15.4	640	1
SMF10A	AX	NX	11.1	1	10	0.1	11.8	17	562	1
SMF11A	AZ	NZ	12.2	1	11	0.1	11	18.2	509	1
SMF12A	BE	OE	13.3	1	12	0.1	10.1	19.9	483	1
SMF13A	BG	OG	14.4	1	13	0.1	9.3	21.5	423	1
SMF14A	BK	OK	15.6	1	14	0.1	8.6	23.2	392	1
SMF15A	BM	OM	16.7	1	15	0.1	8.2	24.4	367	1
SMF16A	BP	OP	17.8	1	16	0.1	7.7	26	343	1
SMF17A	BR	OR	18.9	1	17	0.1	7.2	27.6	324	1
SMF18A	BT	OT	20	1	18	0.1	6.8	29.2	320	1
SMF20A	BV	OV	22.2	1	20	0.1	6.2	32.4	283	1
SMF22A	BX	OX	24.4	1	22	0.1	5.6	35.5	271	1
SMF24A	BZ	OZ	26.7	1	24	0.1	5.1	38.9	244	1
SMF26A	CE	PE	28.9	1	26	0.1	4.8	42.1	230	1
SMF28A	CG	PG	31.1	1	28	0.1	4.4	45.4	227	1
SMF30A	CK	PK	33.3	1	30	0.1	4.1	48.4	207	1
SMF33A	CM	PM	36.7	1	33	0.1	3.8	53.3	198	1
SMF36A	CP	PP	40	1	36	0.1	3.4	58.1	178	1
SMF40A	CR	PR	44.4	1	40	0.1	3.1	64.5	172	1
SMF43A	CT	PT	47.8	1	43	0.1	2.9	69.4	165	1
SMF45A	CV	PV	50	1	45	0.1	2.8	72.7	162	1
SMF48A	CX	PX	53.3	1	48	0.1	2.6	77.4	161	1
SMF51A	CZ	PZ	56.7	1	51	0.1	2.4	82.4	151	1
SMF54A	CA	PA	60	1	54	0.1	2.25	88	148	1
SMF58A	CC	PC	64.4	1	58	0.1	2.1	95	144	1

## TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

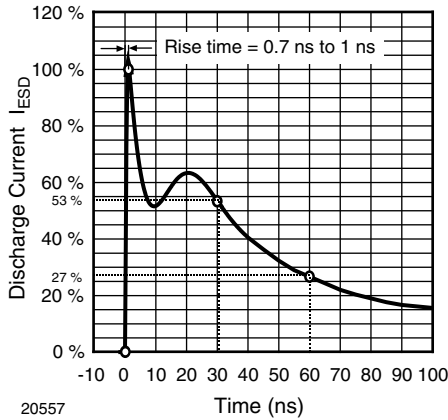


Fig. 1 - ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 Ω/150pF)

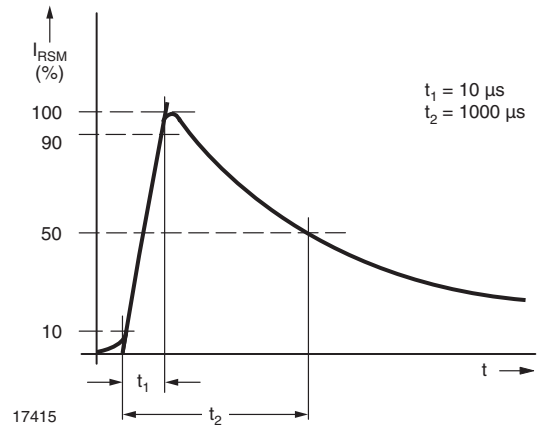


Fig. 4 - Pulse Waveform

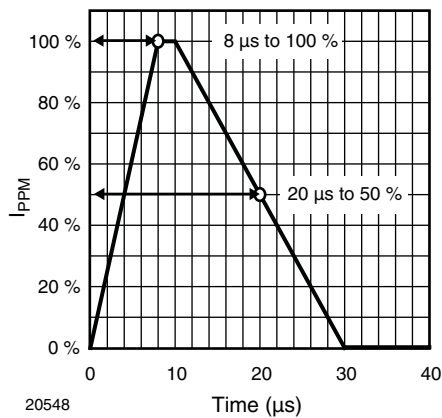


Fig. 2 - 8/20 μs Peak Pulse Current Wave Form acc. IEC 61000-4-5

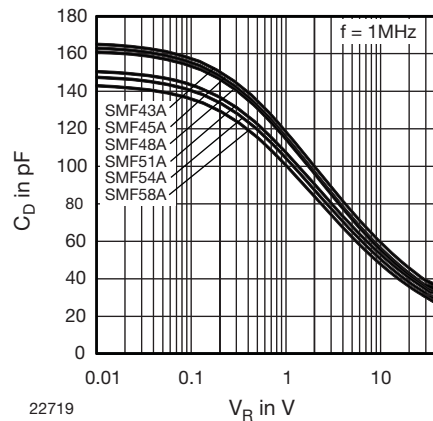


Fig. 5 - Typical Capacitance C<sub>D</sub> vs. Reverse Voltage V<sub>R</sub>

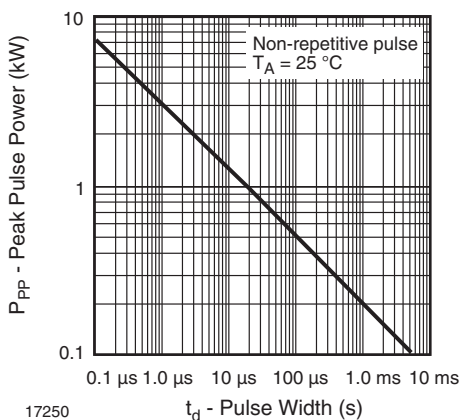


Fig. 3 - Peak Pulse Power Rating

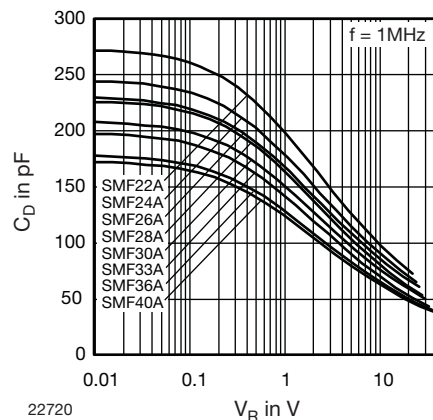


Fig. 6 - Typical Capacitance C<sub>D</sub> vs. Reverse Voltage V<sub>R</sub>

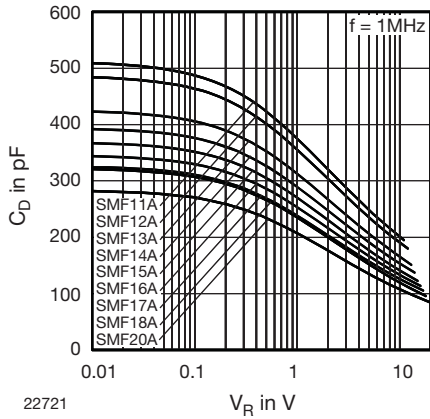


Fig. 7 - Typical Capacitance  $C_D$  vs. Reverse Voltage  $V_R$

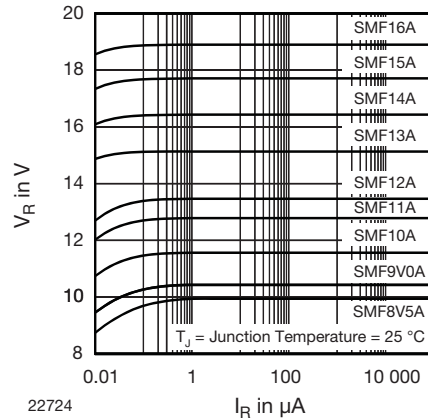


Fig. 10 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$

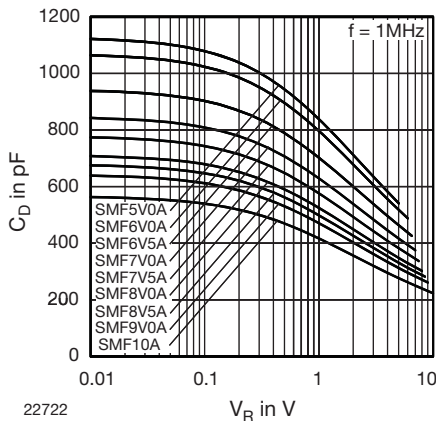


Fig. 8 - Typical Capacitance  $C_D$  vs. Reverse Voltage  $V_R$

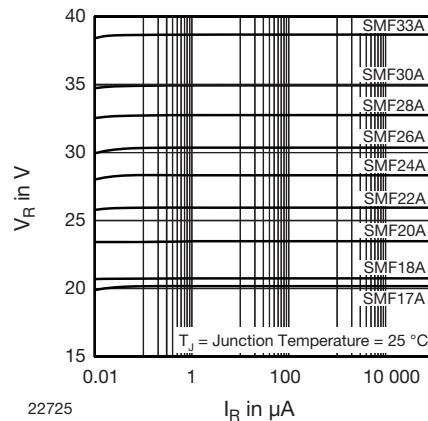


Fig. 11 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$

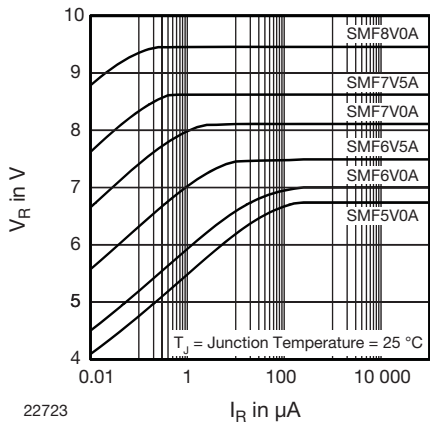


Fig. 9 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$

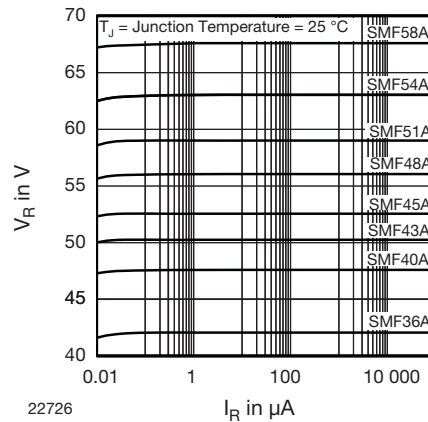
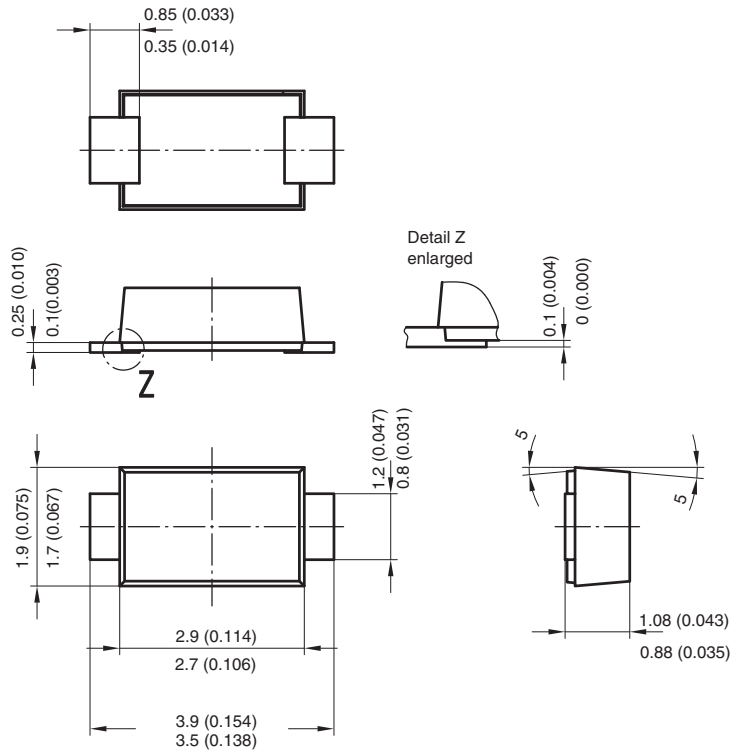


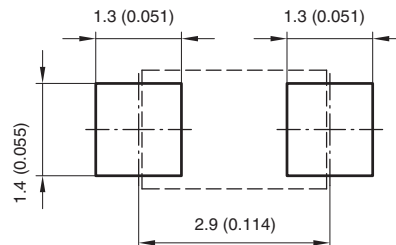
Fig. 12 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$



## PACKAGE DIMENSIONS in millimeters (inches): SMF



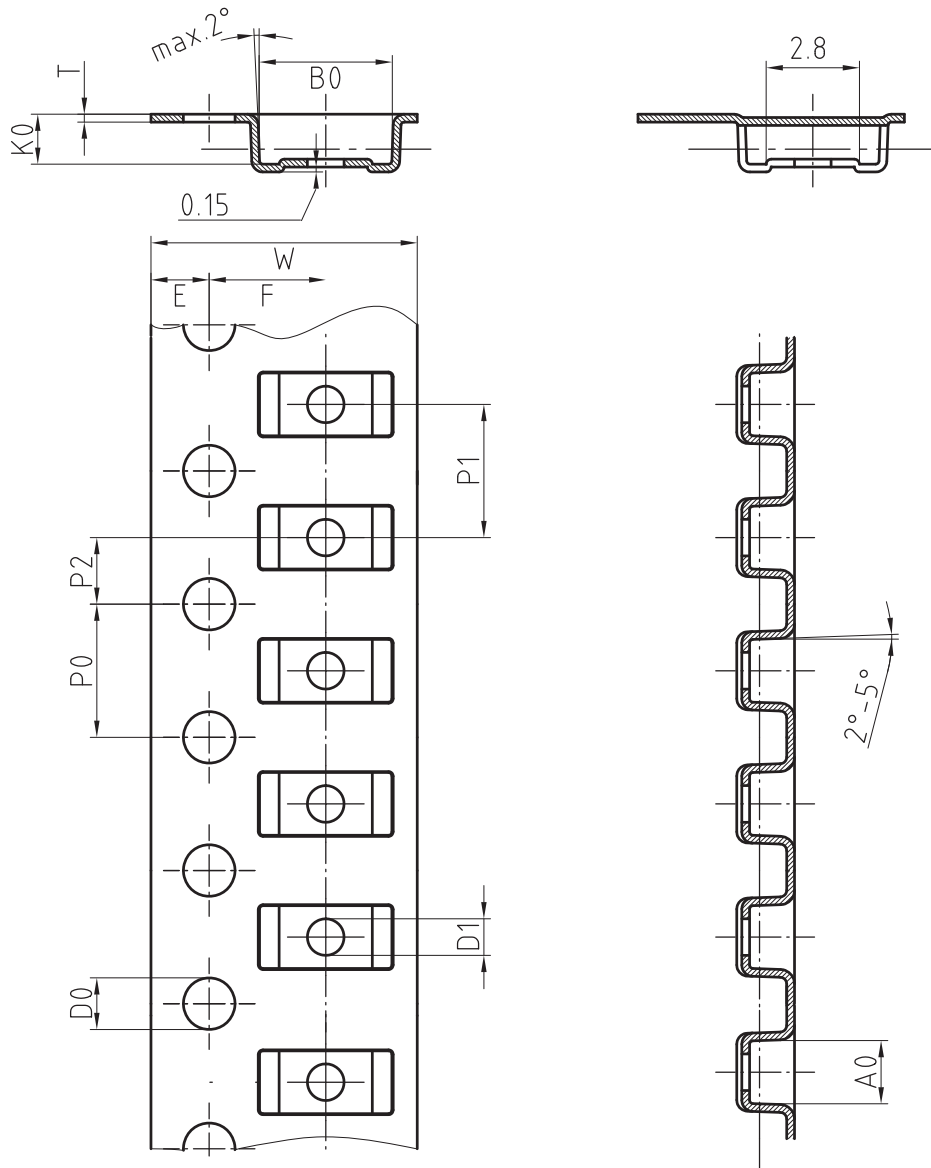
Foot print recommendation:



Created - Date: 15. February 2005  
Rev. 3 - Date: 13. March 2007  
Document no.:S8-V-3915.01-001 (4)  
17247



## BLISTERTAPE DIMENSIONS in millimeters (inches)



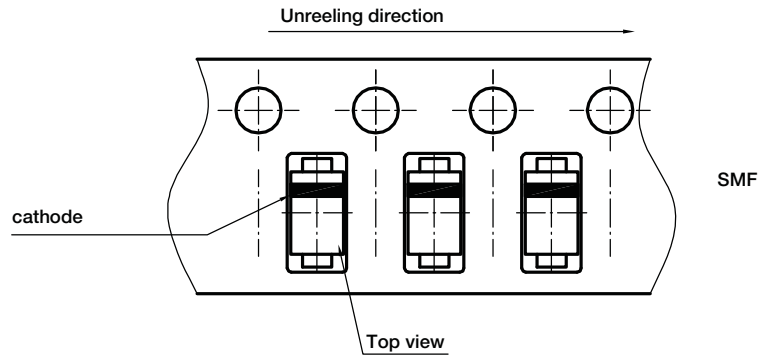
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PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

Document-No.: S8-V-3717.02-001 (3)

18513



**ORIENTATION IN CARRIER TAPE - SMF**



Document no.: S8-V-3717.02-003 (4)  
Created - Date: 09. Feb. 2010  
22670



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